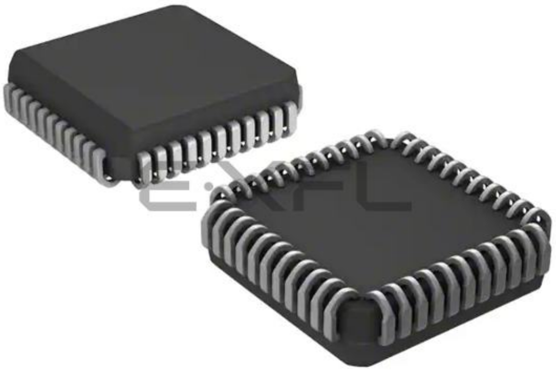

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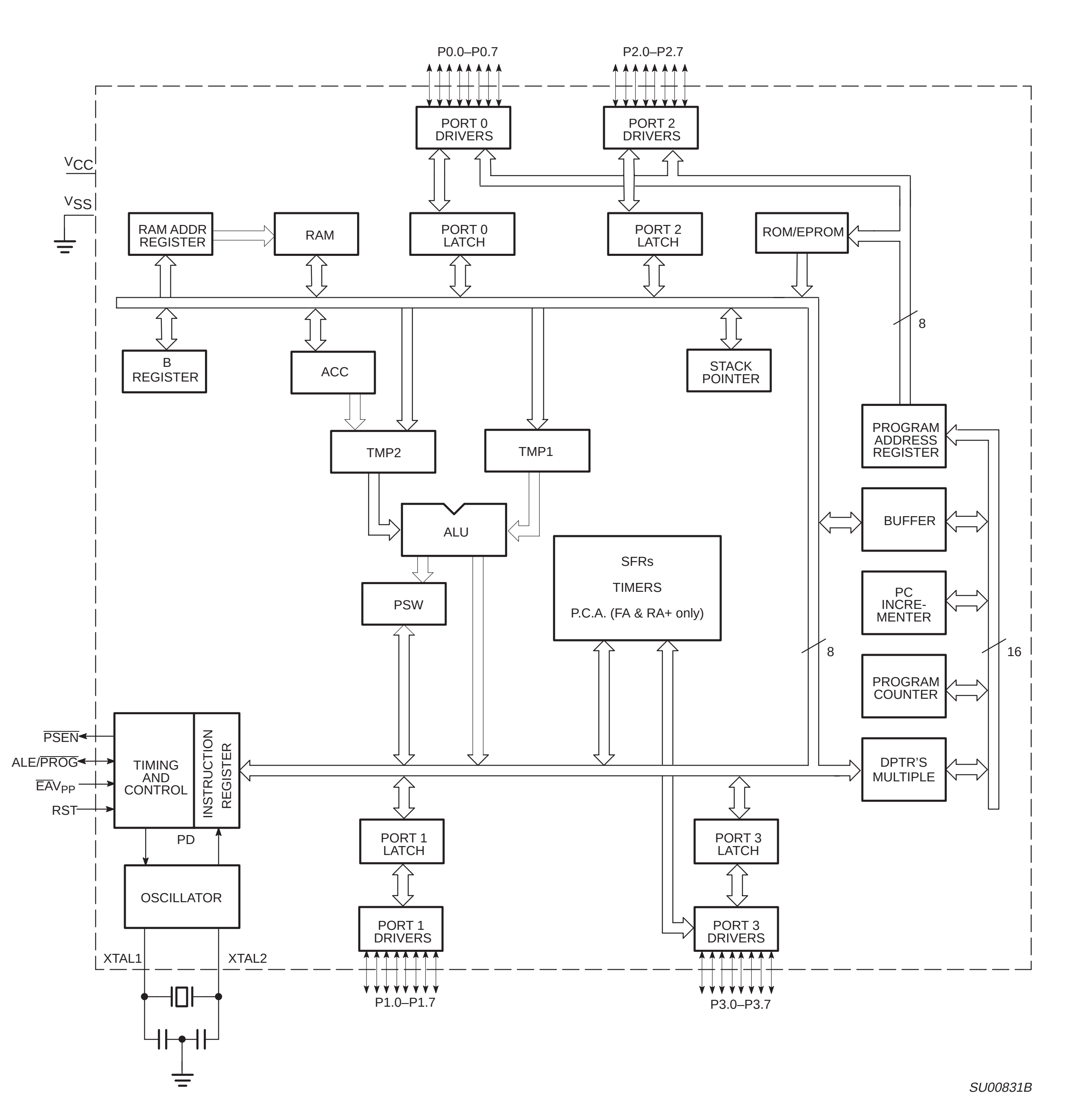
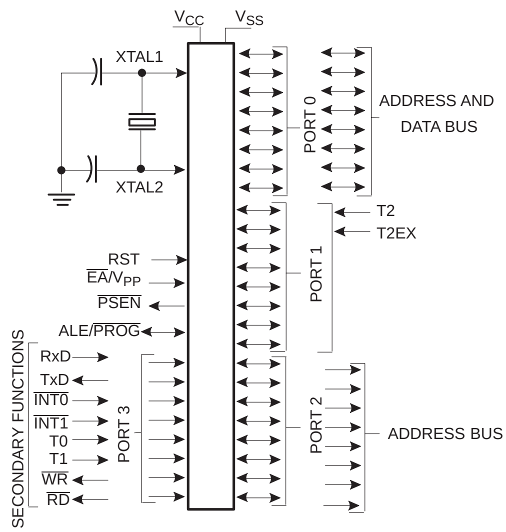
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	16MHz
Connectivity	EBI/EMI, UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	16KB (16K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/p87c54sbaa-512

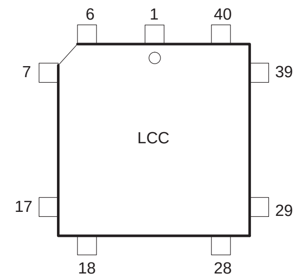
BLOCK DIAGRAM



LOGIC SYMBOL



PLASTIC LEADED CHIP CARRIER PIN FUNCTIONS



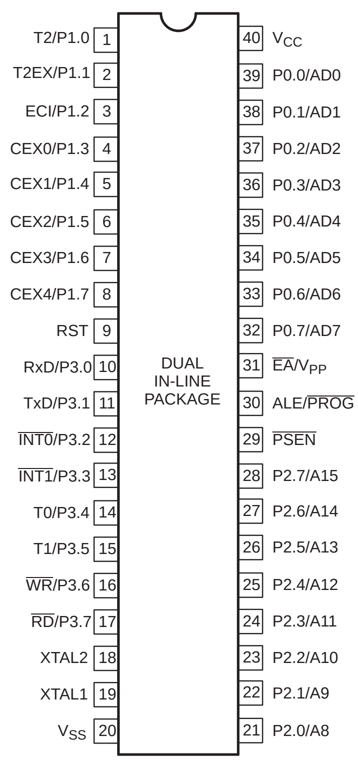
Pin	Function	Pin	Function	Pin	Function
1	NIC*	16	P3.4/T0	31	P2.7/A15
2	P1.0/T2	17	P3.5/T1	32	$\overline{PSEN}$
3	P1.1/T2EX	18	P3.6/$\overline{WR}$	33	ALE/$\overline{PROG}$
4	P1.2/ECI	19	P3.7/$\overline{RD}$	34	NIC*
5	P1.3/CEX0	20	XTAL2	35	$\overline{EA}/V_{PP}$
6	P1.4/CEX1	21	XTAL1	36	P0.7/AD7
7	P1.5/CEX2	22	V_{SS}	37	P0.6/AD6
8	P1.6/CEX3	23	NIC*	38	P0.5/AD5
9	P1.7/CEX4	24	P2.0/A8	39	P0.4/AD4
10	RST	25	P2.1/A9	40	P0.3/AD3
11	P3.0/RxD	26	P2.2/A10	41	P0.2/AD2
12	NIC*	27	P2.3/A11	42	P0.1/AD1
13	P3.1/TxD	28	P2.4/A12	43	P0.0/AD0
14	P3.2/$\overline{INT0}$	29	P2.5/A13	44	V_{CC}
15	P3.3/$\overline{INT1}$	30	P2.6/A14		

* NO INTERNAL CONNECTION

SU00023

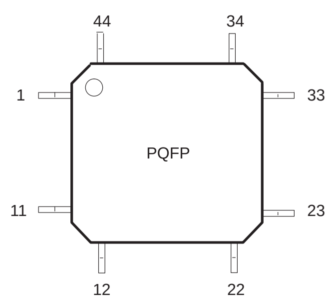
PIN CONFIGURATIONS

DUAL IN-LINE PACKAGE PIN FUNCTIONS



SU00021

PLASTIC QUAD FLAT PACK PIN FUNCTIONS



Pin	Function	Pin	Function	Pin	Function
1	P1.5/CEX2	16	V_{SS}	31	P0.6/AD6
2	P1.6/CEX3	17	NIC*	32	P0.5/AD5
3	P1.7/CEX4	18	P2.0/A8	33	P0.4/AD4
4	RST	19	P2.1/A9	34	P0.3/AD3
5	P3.0/RxD	20	P2.2/A10	35	P0.2/AD2
6	NIC*	21	P2.3/A11	36	P0.1/AD1
7	P3.1/TxD	22	P2.4/A12	37	P0.0/AD0
8	P3.2/$\overline{INT0}$	23	P2.5/A13	38	V_{CC}
9	P3.3/$\overline{INT1}$	24	P2.6/A14	39	NIC*
10	P3.4/T0	25	P2.7/A15	40	P1.0/T2
11	P3.5/T1	26	$\overline{PSEN}$	41	P1.1/T2EX
12	P3.6/$\overline{WR}$	27	ALE/$\overline{PROG}$	42	P1.2/ECI
13	P3.7/$\overline{RD}$	28	NIC*	43	P1.3/CEX0
14	XTAL2	29	$\overline{EA}/V_{PP}$	44	P1.4/CEX1
15	XTAL1	30	P0.7/AD7		

* NO INTERNAL CONNECTION

SU00024

PIN DESCRIPTIONS

MNEMONIC	PIN NUMBER DIP	LCC	QFP	TYPE	NAME AND FUNCTION
V_{SS}	20	22	16	I	**Ground:** 0 V reference.
V_{CC}	40	44	38	I	**Power Supply:** This is the power supply voltage for normal, idle, and power-down operation.
P0.0–0.7	39–32	43–36	37–30	I/O	**Port 0:** Port 0 is an open-drain, bidirectional I/O port. Port 0 pins that have 1s written to them float and can be used as high-impedance inputs. Port 0 is also the multiplexed low-order address and data bus during accesses to external program and data memory. In this application, it uses strong internal pull-ups when emitting 1s. Port 0 also outputs the code bytes during program verification and received code bytes during EPROM programming. External pull-ups are required during program verification.
P1.0–P1.7	1–8	2–9	40–44, 1–3	I/O	**Port 1:** Port 1 is an 8-bit bidirectional I/O port with internal pull-ups. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 1 pins that are externally pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I_{IL}). Port 1 also receives the low-order address byte during program memory verification.
					Alternate functions for 8XC51FX and 8XC51RX+ Port 1 include:
	1	2	40	I/O	**T2 (P1.0):** Timer/Counter 2 external count input/Clockout (see Programmable Clock-Out)
	2	3	41	I	**T2EX (P1.1):** Timer/Counter 2 Reload/Capture/Direction Control
	3	4	42	I	**ECI (P1.2):** External Clock Input to the PCA
	4	5	43	I/O	**CEX0 (P1.3):** Capture/Compare External I/O for PCA module 0
	5	6	44	I/O	**CEX1 (P1.4):** Capture/Compare External I/O for PCA module 1
	6	7	1	I/O	**CEX2 (P1.5):** Capture/Compare External I/O for PCA module 2
	7	8	2	I/O	**CEX3 (P1.6):** Capture/Compare External I/O for PCA module 3
	8	9	3	I/O	**CEX4 (P1.7):** Capture/Compare External I/O for PCA module 4
P2.0–P2.7	21–28	24–31	18–25	I/O	**Port 2:** Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 2 pins that are externally being pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I_{IL}). Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOV @Ri), port 2 emits the contents of the P2 special function register. Some Port 2 pins receive the high order address bits during EPROM programming and verification.
P3.0–P3.7	10–17	11, 13–19	5, 7–13	I/O	**Port 3:** Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 3 pins that are externally being pulled low will source current because of the pull-ups. (See DC Electrical Characteristics: I_{IL}). Port 3 also serves the special features of the 80C51 family, as listed below:
	10	11	5	I	**RxD (P3.0):** Serial input port
	11	13	7	O	**TxD (P3.1):** Serial output port
	12	14	8	I	**$\overline{INT0}$ (P3.2):** External interrupt
	13	15	9	I	**$\overline{INT1}$ (P3.3):** External interrupt
	14	16	10	I	**T0 (P3.4):** Timer 0 external input
	15	17	11	I	**T1 (P3.5):** Timer 1 external input
	16	18	12	O	**$\overline{WR}$ (P3.6):** External data memory write strobe
	17	19	13	O	**$\overline{RD}$ (P3.7):** External data memory read strobe
RST	9	10	4	I	**Reset:** A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to V_{SS} permits a power-on reset using only an external capacitor to V_{CC}.
ALE/$\overline{PROG}$	30	33	27	O	**Address Latch Enable/Program Pulse:** Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input ($\overline{PROG}$) during EPROM programming. ALE can be disabled by setting SFR auxiliary.0. With this bit set, ALE will be active only during a MOVX instruction.

87C51RA+/RB+/RC+/RD+ AND 80C51RA+ ORDERING INFORMATION

	MEMORY SIZE 8K × 8	MEMORY SIZE 16K × 8	MEMORY SIZE 32K × 8	MEMORY SIZE 64K × 8	ROMless	TEMPERATURE RANGE °C AND PACKAGE	VOLTAGE RANGE	FREQ. (MHz)	DWG. #
ROM	P83C51RA+4N	P83C51RB+4N	P83C51RC+4N	P83C51RD+4N	P80C51RA+4N	0 to +70, 40-Pin Plastic Dual In-line Pkg.	2.7V to 5.5V	0 to 16	SOT129-1
OTP	P87C51RA+4N	P87C51RB+4N	P87C51RC+4N	P87C51RD+4N					
ROM	P83C51RA+4A	P83C51RB+4A	P83C51RC+4A	P83C51RD+4A	P80C51RA+4A	0 to +70, 44-Pin Plastic Leaded Chip Carrier	2.7V to 5.5V	0 to 16	SOT187-2
OTP	P87C51RA+4A	P87C51RB+4A	P87C51RC+4A	P87C51RD+4A					
ROM	P83C51RA+4B	P83C51RB+4B	P83C51RC+4B	P83C51RD+4B	P80C51RA+4B	0 to +70, 44-Pin Plastic Quad Flat Pack	2.7V to 5.5V	0 to 16	SOT307-2
OTP	P87C51RA+4B	P87C51RB+4B	P87C51RC+4B	P87C51RD+4B					
ROM	P83C51RA+5N	P83C51RB+5N	P83C51RC+5N	P83C51RD+5N	P80C51RA+5N	–40 to +85, 40-Pin Plastic Dual In-line Pkg.	2.7V to 5.5V	0 to 16	SOT129-1
OTP	P87C51RA+5N	P87C51RB+5N	P87C51RC+5N	P87C51RD+5N					
ROM	P83C51RA+5A	P83C51RB+5A	P83C51RC+5A	P83C51RD+5A	P80C51RA+5A	–40 to +85, 44-Pin Plastic Leaded Chip Carrier	2.7V to 5.5V	0 to 16	SOT187-2
OTP	P87C51RA+5A	P87C51RB+5A	P87C51RC+5A	P87C51RD+5A					
ROM	P83C51RA+5B	P83C51RB+5B	P83C51RC+5B	P83C51RD+5B	P80C51RA+5B	–40 to +85, 44-Pin Plastic Quad Flat Pack	2.7V to 5.5V	0 to 16	SOT307-2
OTP	P87C51RA+5B	P87C51RB+5B	P87C51RC+5B	P87C51RD+5B					
ROM	P83C51RA+IN	P83C51RB+IN	P83C51RC+IN	P83C51RD+IN	P80C51RA+IN	0 to +70, 40-Pin Plastic Dual In-line Pkg.	5V	0 to 33	SOT129-1
OTP	P87C51RA+IN	P87C51RB+IN	P87C51RC+IN	P87C51RD+IN					
ROM	P83C51RA+IA	P83C51RB+IA	P83C51RC+IA	P83C51RD+IA	P80C51RA+IA	0 to +70, 44-Pin Plastic Leaded Chip Carrier	5V	0 to 33	SOT187-2
OTP	P87C51RA+IA	P87C51RB+IA	P87C51RC+IA	P87C51RD+IA					
ROM	P83C51RA+IB	P83C51RB+IB	P83C51RC+IB	P83C51RD+IB	P80C51RA+IB	0 to +70, 44-Pin Plastic Quad Flat Pack	5V	0 to 33	SOT307-2
OTP	P87C51RA+IB	P87C51RB+IB	P87C51RC+IB	P87C51RD+IB					
ROM	P83C51RA+JN	P83C51RB+JN	P83C51RC+JN	P83C51RD+JN	P80C51RA+JN	–40 to +85, 40-Pin Plastic Dual In-line Pkg.	5V	0 to 33	SOT129-1
OTP	P87C51RA+JN	P87C51RB+JN	P87C51RC+JN	P87C51RD+JN					
ROM	P83C51RA+JA	P83C51RB+JA	P83C51RC+JA	P83C51RD+JA	P80C51RA+JA	–40 to +85, 44-Pin Plastic Leaded Chip Carrier	5V	0 to 33	SOT187-2
OTP	P87C51RA+JA	P87C51RB+JA	P87C51RC+JA	P87C51RD+JA					
ROM	P83C51RA+JB	P83C51RB+JB	P83C51RC+JB	P83C51RD+JB	P80C51RA+JB	–40 to +85, 44-Pin Plastic Quad Flat Pack	5V	0 to 33	SOT307-2
OTP	P87C51RA+JB	P87C51RB+JB	P87C51RC+JB	P87C51RD+JB					

Note: For Multi Time Programmable devices, See P89C51RX+ Flash datasheet.

Table 2. 8XC51FA/FB/FC, 8XC51RA+/RB+/RC+/RD+ Special Function Registers

SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT ADDRESS, SYMBOL, OR ALTERNATIVE PORT FUNCTION MSB							LSB	RESET VALUE
ACC*	Accumulator	E0H	E7	E6	E5	E4	E3	E2	E1	E0	00H
AUXR#	Auxiliary	8EH	–	–	–	–	–	–	EXTRAM (RX+ only)	AO	xxxxxx00B
AUXR1#	Auxiliary 1	A2H	–	–	–	LPEP[3]	GF3	0	–	DPS	xxx0xxx0B
B*	B register	F0H	F7	F6	F5	F4	F3	F2	F1	F0	00H
CCAP0H#	Module 0 Capture High	FAH									xxxxxxxxB
CCAP1H#	Module 1 Capture High	FBH									xxxxxxxxB
CCAP2H#	Module 2 Capture High	FCH									xxxxxxxxB
CCAP3H#	Module 3 Capture High	FDH									xxxxxxxxB
CCAP4H#	Module 4 Capture High	FEH									xxxxxxxxB
CCAP0L#	Module 0 Capture Low	EAH									xxxxxxxxB
CCAP1L#	Module 1 Capture Low	EBH									xxxxxxxxB
CCAP2L#	Module 2 Capture Low	ECH									xxxxxxxxB
CCAP3L#	Module 3 Capture Low	EDH									xxxxxxxxB
CCAP4L#	Module 4 Capture Low	EEH									xxxxxxxxB
CCAPM0#	Module 0 Mode	DAH	–	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
CCAPM1#	Module 1 Mode	DBH	–	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
CCAPM2#	Module 2 Mode	DCH	–	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
CCAPM3#	Module 3 Mode	DDH	–	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
CCAPM4#	Module 4 Mode	DEH	–	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
			DF	DE	DD	DC	DB	DA	D9	D8	
CCON*#	PCA Counter Control	D8H	CF	CR	–	CCF4	CCF3	CCF2	CCF1	CCF0	00x00000B
CH#	PCA Counter High	F9H									00H
CL#	PCA Counter Low	E9H									00H
CMOD#	PCA Counter Mode	D9H	CIDL	WDTE	–	–	–	CPS1	CPS0	ECF	00xxx000B
DPTR:	Data Pointer (2 bytes)										
DPH	Data Pointer High	83H									00H
DPL	Data Pointer Low	82H									00H
			AF	AE	AD	AC	AB	AA	A9	A8	
IE*	Interrupt Enable	A8H	EA	EC	ET2	ES	ET1	EX1	ET0	EX0	00H
			BF	BE	BD	BC	BB	BA	B9	B8	
IP*	Interrupt Priority	B8H	–	PPC	PT2	PS	PT1	PX1	PT0	PX0	x0000000B
			B7	B6	B5	B4	B3	B2	B1	B0	
IPH#	Interrupt Priority High	B7H	–	PPCH	PT2H	PSH	PT1H	PX1H	PT0H	PX0H	x0000000B
			87	86	85	84	83	82	81	80	
P0*	Port 0	80H	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	FFH
			97	96	95	94	93	92	91	90	
P1*	Port 1	90H	CEX4	CEX3	CEX2	CEX1	CEX0	ECI	T2EX	T2	FFH
			A7	A6	A5	A4	A3	A2	A1	A0	
P2*	Port 2	A0H	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8	FFH
			B7	B6	B5	B4	B3	B2	B1	B0	
P3*	Port 3	B0H	$\overline{RD}$	$\overline{WR}$	T1	T0	$\overline{INT1}$	$\overline{INT0}$	TxD	RxD	FFH
PCON#[1]	Power Control	87H	SMOD1	SMOD0	–	POF[2]	GF1	GF0	PD	IDL	00xx0000B

* SFRs are bit addressable.
\# SFRs are modified from or added to the 80C51 SFRs.
– Reserved bits.
1. Reset value depends on reset source.
2. Bit will not be affected by Reset.
3. LPEP – Low Power OTP–EPROM only operation.

Table 2. 8XC51FA/FB/FC, 8XC51RA+/RB+/RC+/RD+ Special Function Registers (Continued)

SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT ADDRESS, SYMBOL, OR ALTERNATIVE PORT FUNCTION MSB							LSB	RESET VALUE
			D7	D6	D5	D4	D3	D2	D1	D0	
PSW*	Program Status Word	D0H	CY	AC	F0	RS1	RS0	OV	–	P	000000x0B
RACAP2H#	Timer 2 Capture High	CBH									00H
RACAP2L#	Timer 2 Capture Low	CAH									00H
SADDR#	Slave Address	A9H									00H
SADEN#	Slave Address Mask	B9H									00H
SBUF	Serial Data Buffer	99H									xxxxxxxxB
			9F	9E	9D	9C	9B	9A	99	98	
SCON*	Serial Control	98H	SM0/FE	SM1	SM2	REN	TB8	RB8	TI	RI	00H
SP	Stack Pointer	81H									07H
			8F	8E	8D	8C	8B	8A	89	88	
TCON*	Timer Control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	00H
			CF	CE	CD	CC	CB	CA	C9	C8	
T2CON*	Timer 2 Control	C8H	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/$\overline{T2}$	CP/$\overline{RL2}$	00H
T2MOD#	Timer 2 Mode Control	C9H	–	–	–	–	–	–	T2OE	DCEN	xxxxxx00B
TH0	Timer High 0	8CH									00H
TH1	Timer High 1	8DH									00H
TH2#	Timer High 2	CDH									00H
TL0	Timer Low 0	8AH									00H
TL1	Timer Low 1	8BH									00H
TL2#	Timer Low 2	CCH									00H
TMOD	Timer Mode	89H	GATE	C/$\overline{T}$	M1	M0	GATE	C/$\overline{T}$	M1	M0	00H
WDTRST	HDW Watchdog Timer Reset (RX+ only)	0A6H									

* SFRs are bit addressable.
\# SFRs are modified from or added to the 80C51 SFRs.
– Reserved bits.

OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator.

To drive the device from an external clock source, XTAL1 should be driven while XTAL2 is left unconnected. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

RESET

A reset is accomplished by holding the RST pin high for at least two machine cycles (24 oscillator periods), while the oscillator is running. To insure a good power-on reset, the RST pin must be high long enough to allow the oscillator time to start up (normally a few milliseconds) plus two machine cycles. At power-on, the voltage on V_{CC} and RST must come up at the same time for a proper start-up. Ports 1, 2, and 3 will asynchronously be driven to their reset condition when a voltage above V_{IH1} (min.) is applied to RESET.

Enhanced UART

The UART operates in all of the usual modes that are described in the first section of *Data Handbook IC20, 80C51-Based 8-Bit Microcontrollers*. In addition the UART can perform framing error detect by looking for missing stop bits, and automatic address recognition. The UART also fully supports multiprocessor communication as does the standard 80C51 UART.

When used for framing error detect the UART looks for missing stop bits in the communication. A missing bit will set the FE bit in the SCON register. The FE bit shares the SCON.7 bit with SM0 and the function of SCON.7 is determined by PCON.6 (SMOD0) (see Figure 7). If SMOD0 is set then SCON.7 functions as FE. SCON.7 functions as SM0 when SMOD0 is cleared. When used as FE SCON.7 can only be cleared by software. Refer to Figure 8.

Automatic Address Recognition

Automatic Address Recognition is a feature which allows the UART to recognize certain addresses in the serial bit stream by using hardware to make the comparisons. This feature saves a great deal of software overhead by eliminating the need for the software to examine every serial address which passes by the serial port. This feature is enabled by setting the SM2 bit in SCON. In the 9 bit UART modes, mode 2 and mode 3, the Receive Interrupt flag (RI) will be automatically set when the received byte contains either the “Given” address or the “Broadcast” address. The 9 bit mode requires that the 9th information bit is a 1 to indicate that the received information is an address and not data. Automatic address recognition is shown in Figure 9.

The 8 bit mode is called Mode 1. In this mode the RI flag will be set if SM2 is enabled and the information received has a valid stop bit following the 8 address bits and the information is either a Given or Broadcast address.

Mode 0 is the Shift Register mode and SM2 is ignored.

Using the Automatic Address Recognition feature allows a master to selectively communicate with one or more slaves by invoking the Given slave address or addresses. All of the slaves may be contacted by using the Broadcast address. Two special Function Registers are used to define the slave’s address, SADDR, and the address mask, SADEN. SADEN is used to define which bits in the SADDR are to b used and which bits are “don’t care”. The SADEN mask can be logically ANDed with the SADDR to create the “Given” address which the master will use for addressing each of the slaves. Use of the Given address allows multiple slaves to be recognized while excluding others. The following examples will help to show the versatility of this scheme:

Slave 0	SADDR	=	1100 0000
	SADEN	=	1111 1101
	Given	=	1100 00X0
Slave 1	SADDR	=	1100 0000
	SADEN	=	1111 1110
	Given	=	1100 000X

In the above example SADDR is the same and the SADEN data is used to differentiate between the two slaves. Slave 0 requires a 0 in bit 0 and it ignores bit 1. Slave 1 requires a 0 in bit 1 and bit 0 is ignored. A unique address for Slave 0 would be 1100 0010 since slave 1 requires a 0 in bit 1. A unique address for slave 1 would be 1100 0001 since a 1 in bit 0 will exclude slave 0. Both slaves can be selected at the same time by an address which has bit 0 = 0 (for slave 0) and bit 1 = 0 (for slave 1). Thus, both could be addressed with 1100 0000.

In a more complex system the following could be used to select slaves 1 and 2 while excluding slave 0:

Slave 0	SADDR	=	1100 0000
	SADEN	=	1111 1001
	Given	=	1100 0XX0
Slave 1	SADDR	=	1110 0000
	SADEN	=	1111 1010
	Given	=	1110 0X0X
Slave 2	SADDR	=	1110 0000
	SADEN	=	1111 1100
	Given	=	1110 00XX

In the above example the differentiation among the 3 slaves is in the lower 3 address bits. Slave 0 requires that bit 0 = 0 and it can be uniquely addressed by 1110 0110. Slave 1 requires that bit 1 = 0 and it can be uniquely addressed by 1110 and 0101. Slave 2 requires that bit 2 = 0 and its unique address is 1110 0011. To select Slaves 0 and 1 and exclude Slave 2 use address 1110 0100, since it is necessary to make bit 2 = 1 to exclude slave 2.

The Broadcast Address for each slave is created by taking the logical OR of SADDR and SADEN. Zeros in this result are trended as don’t-cares. In most cases, interpreting the don’t-cares as ones, the broadcast address will be FF hexadecimal.

Upon reset SADDR (SFR address 0A9H) and SADEN (SFR address 0B9H) are leaded with 0s. This produces a given address of all “don’t cares” as well as a Broadcast address of all “don’t cares”. This effectively disables the Automatic Addressing mode and allows the microcontroller to use standard 80C51 type UART drivers which do not make use of this feature.

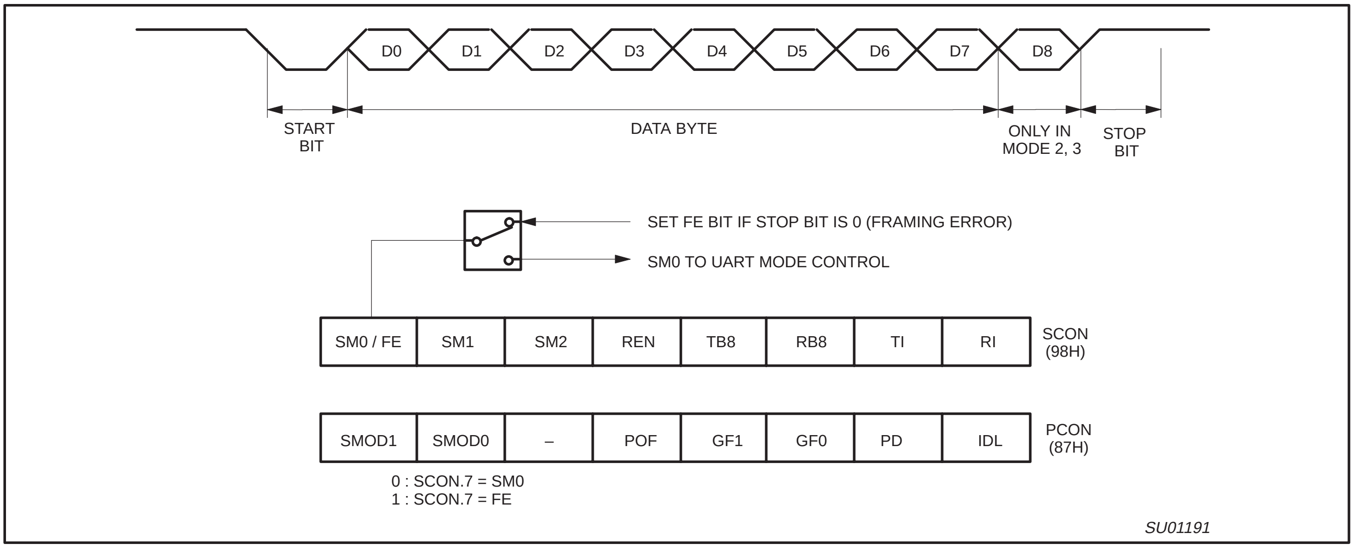


Figure 8. UART Framing Error Detection

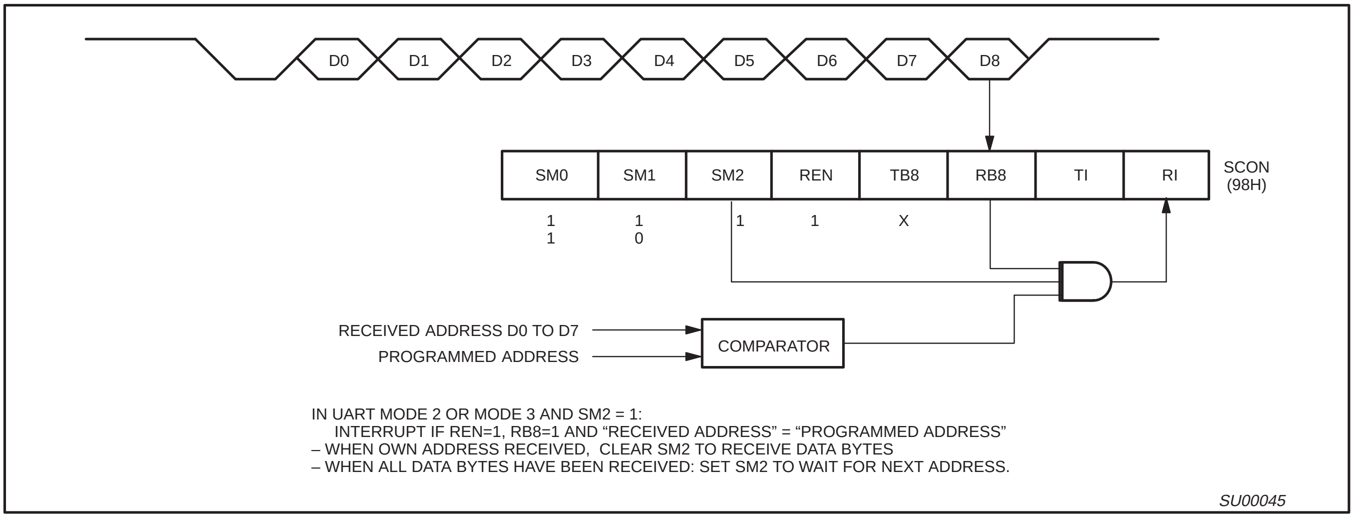


Figure 9. UART Multiprocessor Communication, Automatic Address Recognition

Interrupt Priority Structure

The 8XC51FA/FB/FC and 8XC51RA+/RB+/RC+/RD+ have a 7-source four-level interrupt structure (see Table 8). The 80C54/58 have a 6-source four-level interrupt structure because these devices do not have a PCA.

There are 3 SFRs associated with the four-level interrupt. They are the IE, IP, and IPH. (See Figures 10, 11, and 12.) The IPH (Interrupt Priority High) register makes the four-level interrupt structure possible. The IPH is located at SFR address B7H. The structure of the IPH register and a description of its bits is shown in Figure 12.

The function of the IPH SFR is simple and when combined with the IP SFR determines the priority of each interrupt. The priority of each interrupt is determined as shown in the following table:

PRIORITY BITS		INTERRUPT PRIORITY LEVEL
IPH.x	IP.x	
0	0	Level 0 (lowest priority)
0	1	Level 1
1	0	Level 2
1	1	Level 3 (highest priority)

The priority scheme for servicing the interrupts is the same as that for the 80C51, except there are four interrupt levels rather than two as on the 80C51. An interrupt will be serviced as long as an interrupt of equal or higher priority is not already being serviced. If an interrupt of equal or higher level priority is being serviced, the new interrupt will wait until it is finished before being serviced. If a lower priority level interrupt is being serviced, it will be stopped and the new interrupt serviced. When the new interrupt is finished, the lower priority level interrupt that was stopped will be completed.

Table 8. Interrupt Table

SOURCE	POLLING PRIORITY	REQUEST BITS	HARDWARE CLEAR?	VECTOR ADDRESS
X0	1	IE0	N (L)[1] Y (T)[2]	03H
T0	2	TF0	Y	0B
X1	3	IE1	N (L) Y (T)	13
T1	4	TF1	Y	1B
PCA	5	CF, CCFn n = 0–4	N	33
SP	6	RI, TI	N	23
T2	7	TF2, EXF2	N	2B

NOTES:
1. L = Level activated
2. T = Transition activated

IE (0A8H)

7	6	5	4	3	2	1	0
EA	EC	ET2	ES	ET1	EX1	ET0	EX0

Enable Bit = 1 enables the interrupt.
Enable Bit = 0 disables it.

BIT	SYMBOL	FUNCTION
IE.7	EA	Global disable bit. If EA = 0, all interrupts are disabled. If EA = 1, each interrupt can be individually enabled or disabled by setting or clearing its enable bit.
IE.6	EC	PCA interrupt enable bit for FX and RX+ only – otherwise it is not implemented.
IE.5	ET2	Timer 2 interrupt enable bit.
IE.4	ES	Serial Port interrupt enable bit.
IE.3	ET1	Timer 1 interrupt enable bit.
IE.2	EX1	External interrupt 1 enable bit.
IE.1	ET0	Timer 0 interrupt enable bit.
IE.0	EX0	External interrupt 0 enable bit.

SU00840

Figure 10. IE Registers

(8XC51FX and 8XC51RX+ ONLY)

Programmable Counter Array (PCA) (8XC51FX and 8XC51RX+ only)

The Programmable Counter Array available on the 8XC51FX and 8XC51RX+ is a special 16-bit Timer that has five 16-bit capture/compare modules associated with it. Each of the modules can be programmed to operate in one of four modes: rising and/or falling edge capture, software timer, high-speed output, or pulse width modulator. Each module has a pin associated with it in port 1. Module 0 is connected to P1.3(CEX0), module 1 to P1.4(CEX1), etc. The basic PCA configuration is shown in Figure 14.

The PCA timer is a common time base for all five modules and can be programmed to run at: 1/12 the oscillator frequency, 1/4 the oscillator frequency, the Timer 0 overflow, or the input on the ECI pin (P1.2). The timer count source is determined from the CPS1 and CPS0 bits in the CMOD SFR as follows (see Figure 17):

CPS1	CPS0	PCA Timer Count Source
0	0	1/12 oscillator frequency
0	1	1/4 oscillator frequency
1	0	Timer 0 overflow
1	1	External Input at ECI pin

In the CMOD SFR are three additional bits associated with the PCA. They are CIDL which allows the PCA to stop during idle mode, WDTE which enables or disables the watchdog function on module 4, and ECF which when set causes an interrupt and the PCA overflow flag CF (in the CCON SFR) to be set when the PCA timer overflows. These functions are shown in Figure 15.

The watchdog timer function is implemented in module 4 (see Figure 24).

The CCON SFR contains the run control bit for the PCA and the flags for the PCA timer (CF) and each module (refer to Figure 18). To run the PCA the CR bit (CCON.6) must be set by software. The PCA is shut off by clearing this bit. The CF bit (CCON.7) is set when the PCA counter overflows and an interrupt will be generated if the ECF bit in the CMOD register is set, The CF bit can only be cleared by software. Bits 0 through 4 of the CCON register are the flags for the modules (bit 0 for module 0, bit 1 for module 1, etc.) and are set by hardware when either a match or a capture occurs. These flags also can only be cleared by software. The PCA interrupt system shown in Figure 16.

Each module in the PCA has a special function register associated with it. These registers are: CCAPM0 for module 0, CCAPM1 for module 1, etc. (see Figure 19). The registers contain the bits that control the mode that each module will operate in. The ECCF bit (CCAPMn.0 where n=0, 1, 2, 3, or 4 depending on the module) enables the CCF flag in the CCON SFR to generate an interrupt when a match or compare occurs in the associated module. PWM (CCAPMn.1) enables the pulse width modulation mode. The TOG bit (CCAPMn.2) when set causes the CEX output associated with the module to toggle when there is a match between the PCA counter and the module’s capture/compare register. The match bit MAT (CCAPMn.3) when set will cause the CCFn bit in the CCON register to be set when there is a match between the PCA counter and the module’s capture/compare register.

The next two bits CAPN (CCAPMn.4) and CAPP (CCAPMn.5) determine the edge that a capture input will be active on. The CAPN bit enables the negative edge, and the CAPP bit enables the positive edge. If both bits are set both edges will be enabled and a capture will occur for either transition. The last bit in the register ECOM (CCAPMn.6) when set enables the comparator function. Figure 20 shows the CCAPMn settings for the various PCA functions.

There are two additional registers associated with each of the PCA modules. They are CCAPnH and CCAPnL and these are the registers that store the 16-bit count when a capture occurs or a compare should occur. When a module is used in the PWM mode these registers are used to control the duty cycle of the output.

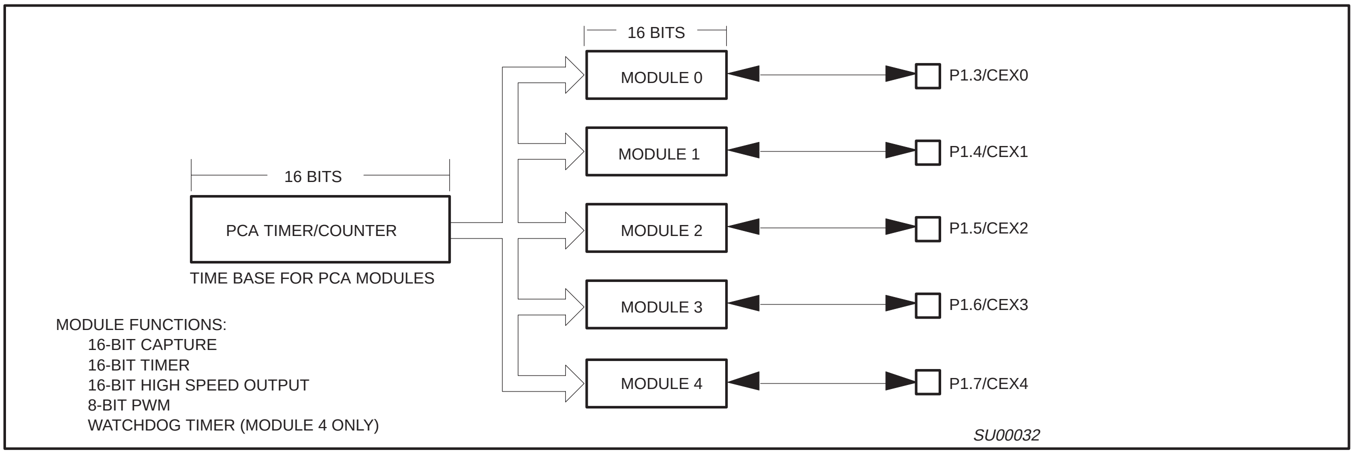


Figure 14. Programmable Counter Array (PCA)

(8XC51FX and 8XC51RX+ ONLY)

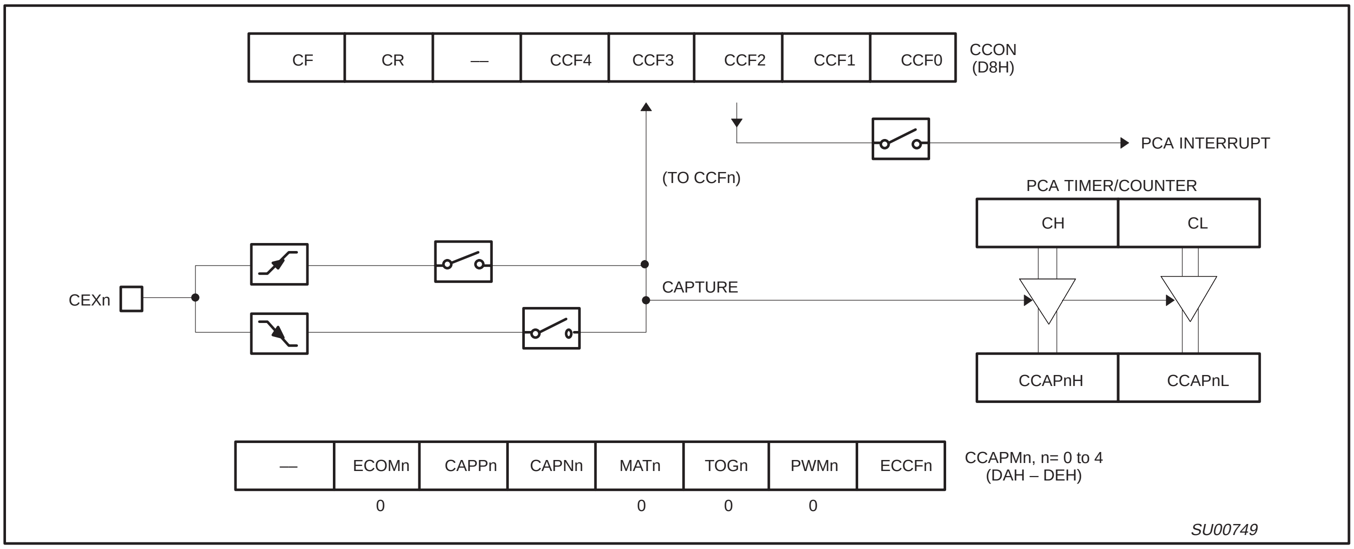


Figure 21. PCA Capture Mode

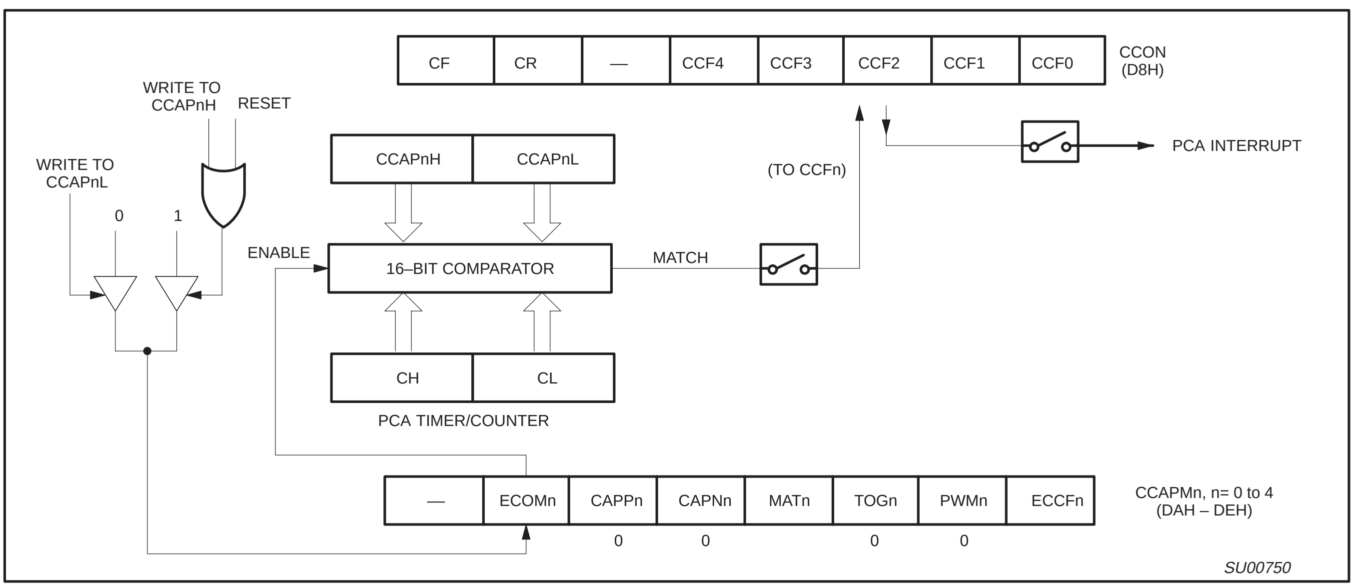


Figure 22. PCA Compare Mode

(8XC51FX and 8XC51RX+ ONLY)

```
INIT_WATCHDOG:
   MOV CCAPM4, #4CH         ; Module 4 in compare mode
   MOV CCAP4L, #0FFH        ; Write to low byte first
   MOV CCAP4H, #0FFH        ; Before PCA timer counts up to
                            ; FFFF Hex, these compare values
                            ; must be changed
   ORL CMOD, #40H           ; Set the WDTE bit to enable the
                            ; watchdog timer without changing
                            ; the other bits in CMOD
;
;*********************************************************************
;
; Main program goes here, but CALL WATCHDOG periodically.
;
;*********************************************************************
;
WATCHDOG:
   CLR EA                   ; Hold off interrupts
   MOV CCAP4L, #00          ; Next compare value is within
   MOV CCAP4H, CH           ; 255 counts of the current PCA
   SETB EA                  ; timer value
   RET
```

Figure 26. PCA Watchdog Timer Initialization Code

DC ELECTRICAL CHARACTERISTICS

T_{amb} = 0°C to +70°C or –40°C to +85°C, 33MHz devices; 5V ±10%; V_{SS} = 0V

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP[1]	MAX	
V_{IL}	Input low voltage	4.5V < V_{CC} < 5.5V	–0.5		0.2V_{CC}–0.1	V
V_{IH}	Input high voltage (ports 0, 1, 2, 3, $\overline{EA}$)		0.2V_{CC}+0.9		V_{CC}+0.5	V
V_{IH1}	Input high voltage, XTAL1, RST		0.7V_{CC}		V_{CC}+0.5	V
V_{OL}	Output low voltage, ports 1, 2, 3 [8]	V_{CC} = 4.5V I_{OL} = 1.6mA[2]			0.4	V
V_{OL1}	Output low voltage, port 0, ALE, $\overline{PSEN}$ [7, 8]	V_{CC} = 4.5V I_{OL} = 3.2mA[2]			0.4	V
V_{OH}	Output high voltage, ports 1, 2, 3 [3]	V_{CC} = 4.5V I_{OH} = –30µA	V_{CC} – 0.7			V
V_{OH1}	Output high voltage (port 0 in external bus mode), ALE[9], $\overline{PSEN}$[3]	V_{CC} = 4.5V I_{OH} = –3.2mA	V_{CC} – 0.7			V
I_{IL}	Logical 0 input current, ports 1, 2, 3	V_{IN} = 0.4V	–1		–50	µA
I_{TL}	Logical 1-to-0 transition current, ports 1, 2, 3[6]	V_{IN} = 2.0V See note 4			–650	µA
I_{LI}	Input leakage current, port 0	0.45 < V_{IN} < V_{CC} – 0.3			±10	µA
I_{CC}	Power supply current (see Figure 36): Active mode (see Note 5) Idle mode (see Note 5) Power-down mode or clock stopped (see Figure 40 for conditions)	See note 5 T_{amb} = 0°C to 70°C T_{amb} = –40°C to +85°C		 3	 50 75	 µA µA
R_{RST}	Internal reset pull-down resistor		40		225	kΩ
C_{IO}	Pin capacitance[10] (except $\overline{EA}$)				15	pF

NOTES:

1. Typical ratings are not guaranteed. The values listed are at room temperature, 5V.
2. Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the V_{OL}s of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100pF), the noise pulse on the ALE pin may exceed 0.8V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. I_{OL} can exceed these conditions provided that no single output sinks more than 5mA and no more than two outputs exceed the test conditions.
3. Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and $\overline{PSEN}$ to momentarily fall below the V_{CC}–0.7 specification when the address bits are stabilizing.
4. Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2V.
5. See Figures 37 through 40 for I_{CC} test conditions and Figure 36 for I_{CC} vs Freq.
   Active mode: $I_{CC(MAX)}$ = (0.9 × FREQ. + 1.1)mA. for all devices except 8XC51RD+; 8XC51RD+ I_{CC} = (0.9 x Freq +2.1) mA
   Idle mode: $I_{CC(MAX)}$ = (0.18 × FREQ. +1.0)mA
6. This value applies to T_{amb} = 0°C to +70°C. For T_{amb} = –40°C to +85°C, I_{TL} = –750µA.
7. Load capacitance for port 0, ALE, and $\overline{PSEN}$ = 100pF, load capacitance for all other outputs = 80pF.
8. Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
   Maximum I_{OL} per port pin: 15mA (*NOTE: This is 85°C specification.)
   Maximum I_{OL} per 8-bit port: 26mA
   Maximum total I_{OL} for all outputs: 71mA
   If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
9. ALE is tested to V_{OH1}, except when ALE is off then V_{OH} is the voltage specification.
10. Pin capacitance is characterized but not tested. Pin capacitance is less than 25pF. Pin capacitance of ceramic package is less than 15pF (except $\overline{EA}$ is 25pF).

AC ELECTRICAL CHARACTERISTICS

T_{amb} = 0°C to +70°C or –40°C to +85°C, V_{CC} = +2.7V to +5.5V, V_{SS} = 0V[1, 2, 3]

SYMBOL	FIGURE	PARAMETER	16MHz CLOCK MIN	16MHz CLOCK MAX	VARIABLE CLOCK MIN	VARIABLE CLOCK MAX	UNIT
$1/t_{CLCL}$	29	Oscillator frequency[5] Speed versions : 4; 5;S			3.5	16	MHz
t_{LHLL}	29	ALE pulse width	85		$2t_{CLCL}$–40		ns
t_{AVLL}	29	Address valid to ALE low	22		t_{CLCL}–40		ns
t_{LLAX}	29	Address hold after ALE low	32		t_{CLCL}–30		ns
t_{LLIV}	29	ALE low to valid instruction in		150		$4t_{CLCL}$–100	ns
t_{LLPL}	29	ALE low to $\overline{PSEN}$ low	32		t_{CLCL}–30		ns
t_{PLPH}	29	$\overline{PSEN}$ pulse width	142		$3t_{CLCL}$–45		ns
t_{PLIV}	29	$\overline{PSEN}$ low to valid instruction in		82		$3t_{CLCL}$–105	ns
t_{PXIX}	29	Input instruction hold after $\overline{PSEN}$	0		0		ns
t_{PXIZ}	29	Input instruction float after $\overline{PSEN}$		37		t_{CLCL}–25	ns
t_{AVIV} [5]	29	Address to valid instruction in		207		$5t_{CLCL}$–105	ns
t_{PLAZ}	29	$\overline{PSEN}$ low to address float		10		10	ns
Data Memory							
t_{RLRH}	30, 31	$\overline{RD}$ pulse width	275		$6t_{CLCL}$–100		ns
t_{WLWH}	30, 31	$\overline{WR}$ pulse width	275		$6t_{CLCL}$–100		ns
t_{RLDV}	30, 31	$\overline{RD}$ low to valid data in		147		$5t_{CLCL}$–165	ns
t_{RHDX}	30, 31	Data hold after $\overline{RD}$	0		0		ns
t_{RHDZ}	30, 31	Data float after $\overline{RD}$		65		$2t_{CLCL}$–60	ns
t_{LLDV}	30, 31	ALE low to valid data in		350		$8t_{CLCL}$–150	ns
t_{AVDV}	30, 31	Address to valid data in		397		$9t_{CLCL}$–165	ns
t_{LLWL}	30, 31	ALE low to $\overline{RD}$ or $\overline{WR}$ low	137	239	$3t_{CLCL}$–50	$3t_{CLCL}$+50	ns
t_{AVWL}	30, 31	Address valid to $\overline{WR}$ low or $\overline{RD}$ low	122		$4t_{CLCL}$–130		ns
t_{QVWX}	30, 31	Data valid to $\overline{WR}$ transition	13		t_{CLCL}–50		ns
t_{WHQX}	30, 31	Data hold after $\overline{WR}$	13		t_{CLCL}–50		ns
t_{QVWH}	31	Data valid to $\overline{WR}$ high	287		$7t_{CLCL}$–150		ns
t_{RLAZ}	30, 31	$\overline{RD}$ low to address float		0		0	ns
t_{WHLH}	30, 31	$\overline{RD}$ or $\overline{WR}$ high to ALE high	23	103	t_{CLCL}–40	t_{CLCL}+40	ns
External Clock							
t_{CHCX}	33	High time	20		20	t_{CLCL}–t_{CLCX}	ns
t_{CLCX}	33	Low time	20		20	t_{CLCL}–t_{CHCX}	ns
t_{CLCH}	33	Rise time		20		20	ns
t_{CHCL}	33	Fall time		20		20	ns
Shift Register							
t_{XLXL}	32	Serial port clock cycle time	750		$12t_{CLCL}$		ns
t_{QVXH}	32	Output data setup to clock rising edge	492		$10t_{CLCL}$–133		ns
t_{XHQX}	32	Output data hold after clock rising edge	8		$2t_{CLCL}$–117		ns
t_{XHDX}	32	Input data hold after clock rising edge	0		0		ns
t_{XHDV}	32	Clock rising edge to input data valid		492		$10t_{CLCL}$–133	ns

NOTES:
1. Parameters are valid over operating temperature range unless otherwise specified.
2. Load capacitance for port 0, ALE, and $\overline{PSEN}$ = 100pF, load capacitance for all other outputs = 80pF.
3. Interfacing the microcontroller to devices with float times up to 45ns is permitted. This limited bus contention will not cause damage to Port 0 drivers.
4. See application note AN457 for external memory interface.
5. Parts are guaranteed to operate down to 0Hz.

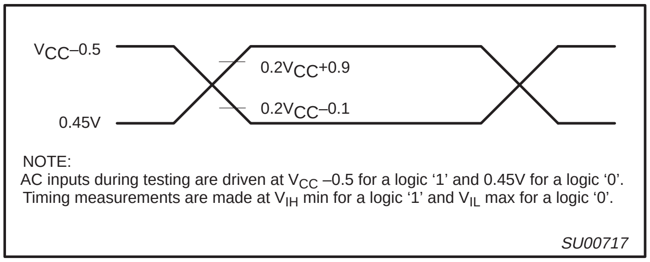


Figure 34. AC Testing Input/Output

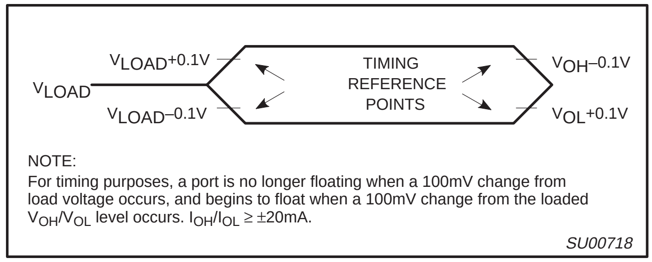


Figure 35. Float Waveform

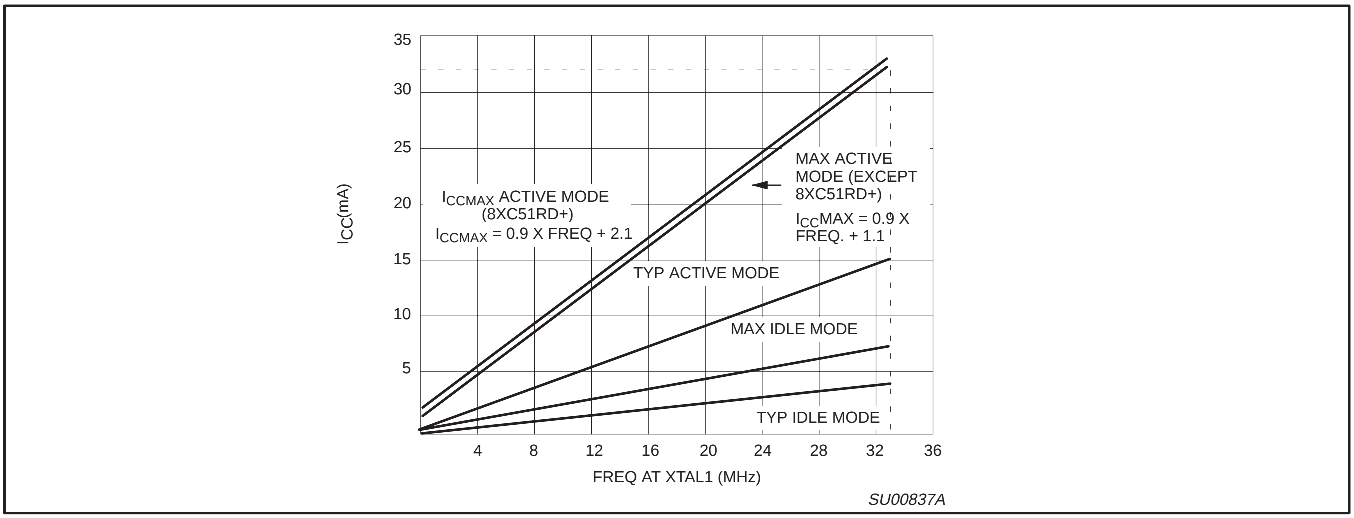


Figure 36. I_{CC} vs. FREQ
Valid only within frequency specifications of the device under test

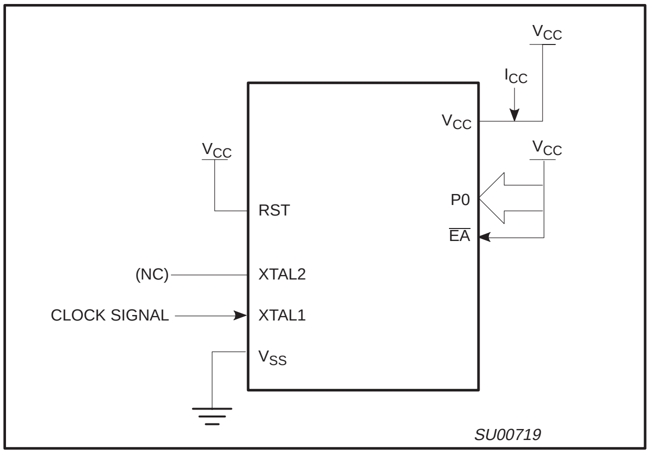


Figure 37. I_{CC} Test Condition, Active Mode
All other pins are disconnected

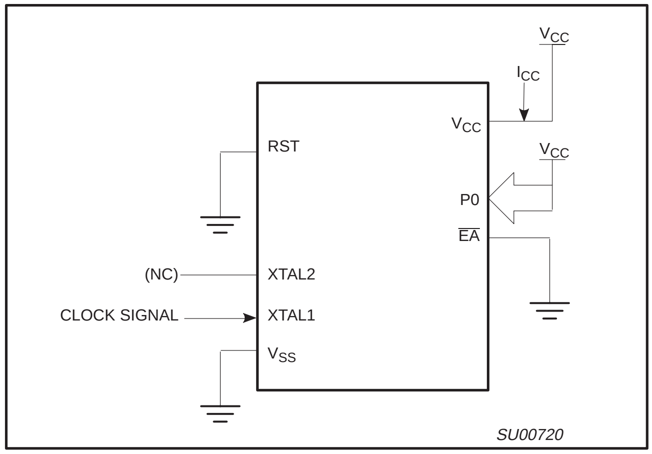


Figure 38. I_{CC} Test Condition, Idle Mode
All other pins are disconnected

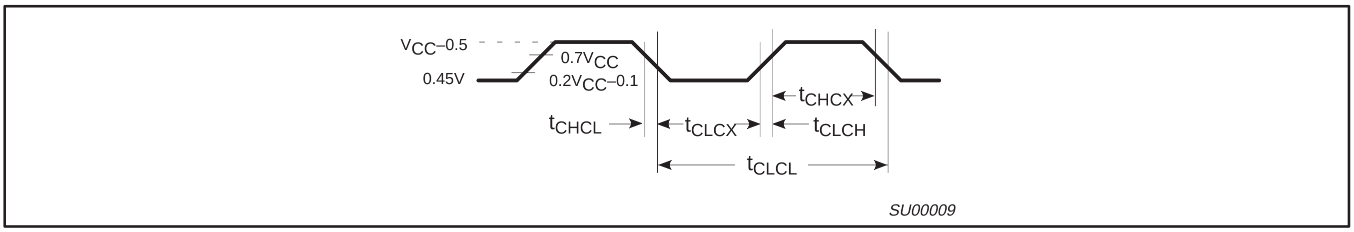


Figure 39. Clock Signal Waveform for I_{CC} Tests in Active and Idle Modes
$t_{CLCH} = t_{CHCL} = 5ns$

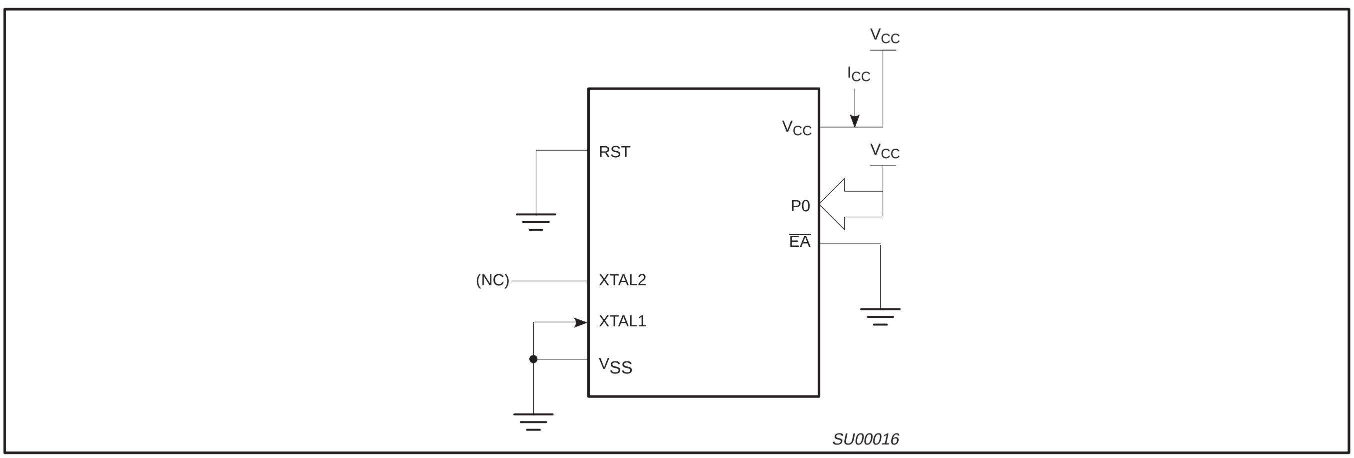


Figure 40. I_{CC} Test Condition, Power Down Mode
All other pins are disconnected. V_{CC} = 2V to 5.5V

EPROM CHARACTERISTICS

All these devices can be programmed by using a modified Improved Quick-Pulse Programming™ algorithm. It differs from older methods in the value used for V_{PP} (programming supply voltage) and in the width and number of the ALE/$\overline{PROG}$ pulses.

The family contains two signature bytes that can be read and used by an EPROM programming system to identify the device. The signature bytes identify the device as being manufactured by Philips.

Table 9 shows the logic levels for reading the signature byte, and for programming the program memory, the encryption table, and the security bits. The circuit configuration and waveforms for quick-pulse programming are shown in Figures 41 and 42. Figure 43 shows the circuit configuration for normal program memory verification.

Quick-Pulse Programming

The setup for microcontroller quick-pulse programming is shown in Figure 41. Note that the device is running with a 4 to 6MHz oscillator. The reason the oscillator needs to be running is that the device is executing internal address and program data transfers.

The address of the EPROM location to be programmed is applied to ports 1 and 2, as shown in Figure 41. The code byte to be programmed into that location is applied to port 0. RST, $\overline{PSEN}$ and pins of ports 2 and 3 specified in Table 9 are held at the 'Program Code Data' levels indicated in Table 9. The ALE/$\overline{PROG}$ is pulsed low 5 times as shown in Figure 42.

To program the encryption table, repeat the 5 pulse programming sequence for addresses 0 through 1FH, using the 'Pgm Encryption Table' levels. Do not forget that after the encryption table is programmed, verification cycles will produce only encrypted data.

To program the security bits, repeat the 5 pulse programming sequence using the 'Pgm Security Bit' levels. After one security bit is programmed, further programming of the code memory and encryption table is disabled. However, the other security bits can still be programmed.

Note that the $\overline{EA}$/V_{PP} pin must not be allowed to go above the maximum specified V_{PP} level for any amount of time. Even a narrow glitch above that voltage can cause permanent damage to the device. The V_{PP} source should be well regulated and free of glitches and overshoot.

Program Verification

If security bits 2 and 3 have not been programmed, the on-chip program memory can be read out for program verification. The address of the program memory locations to be read is applied to ports 1 and 2 as shown in Figure 43. The other pins are held at the 'Verify Code Data' levels indicated in Table 9. The contents of the address location will be emitted on port 0. External pull-ups are required on port 0 for this operation.

If the 64 byte encryption table has been programmed, the data presented at port 0 will be the exclusive NOR of the program byte with one of the encryption bytes. The user will have to know the encryption table contents in order to correctly decode the verification data. The encryption table itself cannot be read out.

Reading the Signature Bytes

The signature bytes are read by the same procedure as a normal verification of locations 030H and 031H, except that P3.6 and P3.7 need to be pulled to a logic low. The values are:

(030H) = 15H indicates manufactured by Philips
(031H) = BBH indicates 87C54
BDH indicates 87C58
B1H indicates 87C51FA
B2H indicates 87C51FB
B3H indicates 87C51FC
CAH indicates 87C51RA+
CBH indicates 87C51RB+
CCH indicates 87C51RC+
CDH indicates 87C51RD+
(060H) = NA

Program/Verify Algorithms

Any algorithm in agreement with the conditions listed in Table 9, and which satisfies the timing specifications, is suitable.

Security Bits

With none of the security bits programmed the code in the program memory can be verified. If the encryption table is programmed, the code will be encrypted when verified. When only security bit 1 (see Table 10) is programmed, MOVC instructions executed from external program memory are disabled from fetching code bytes from the internal memory, EA is latched on Reset and all further programming of the EPROM is disabled. When security bits 1 and 2 are programmed, in addition to the above, verify mode is disabled. When all three security bits are programmed, all of the conditions above apply and all external program memory execution is disabled.

Encryption Array

64 bytes of encryption array are initially unprogrammed (all 1s).

™Trademark phrase of Intel Corporation.

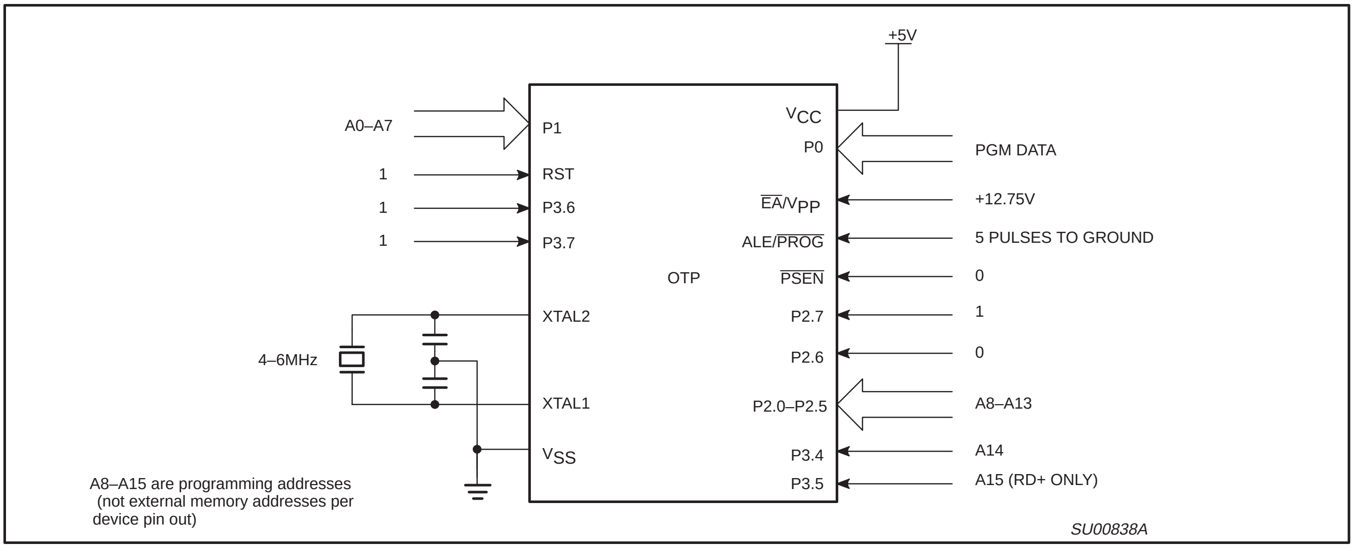


Figure 41. Programming Configuration

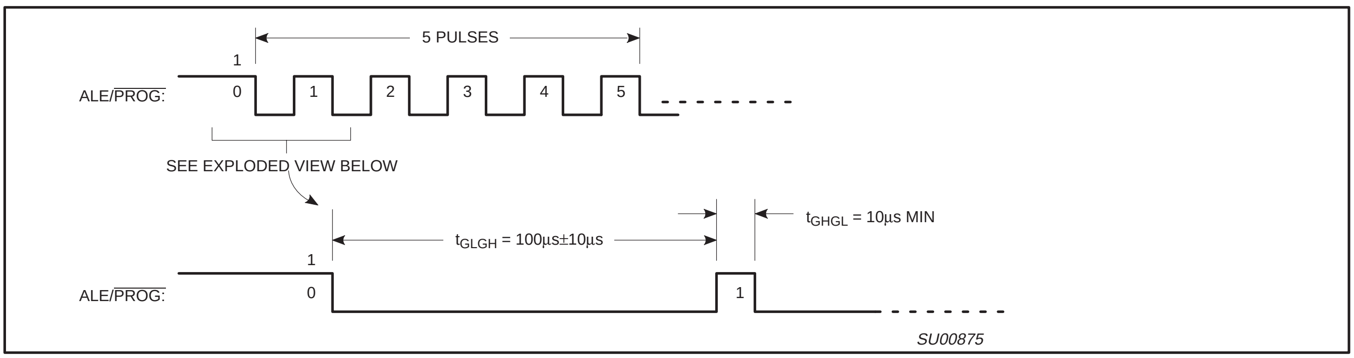


Figure 42. $\overline{\text{PROG}}$ Waveform

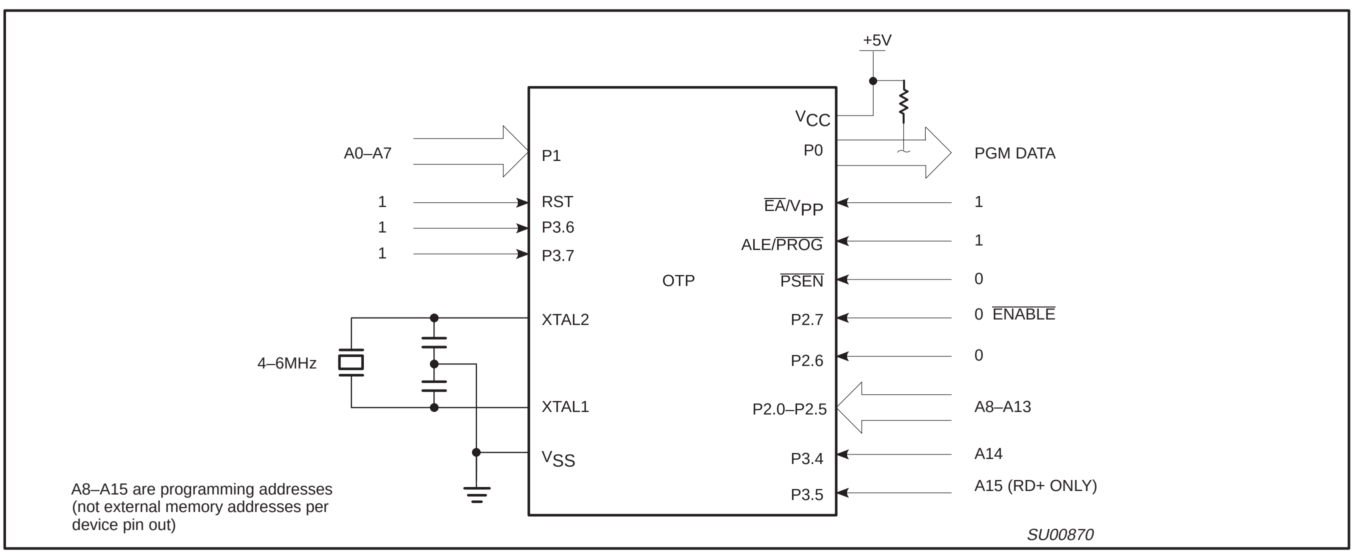


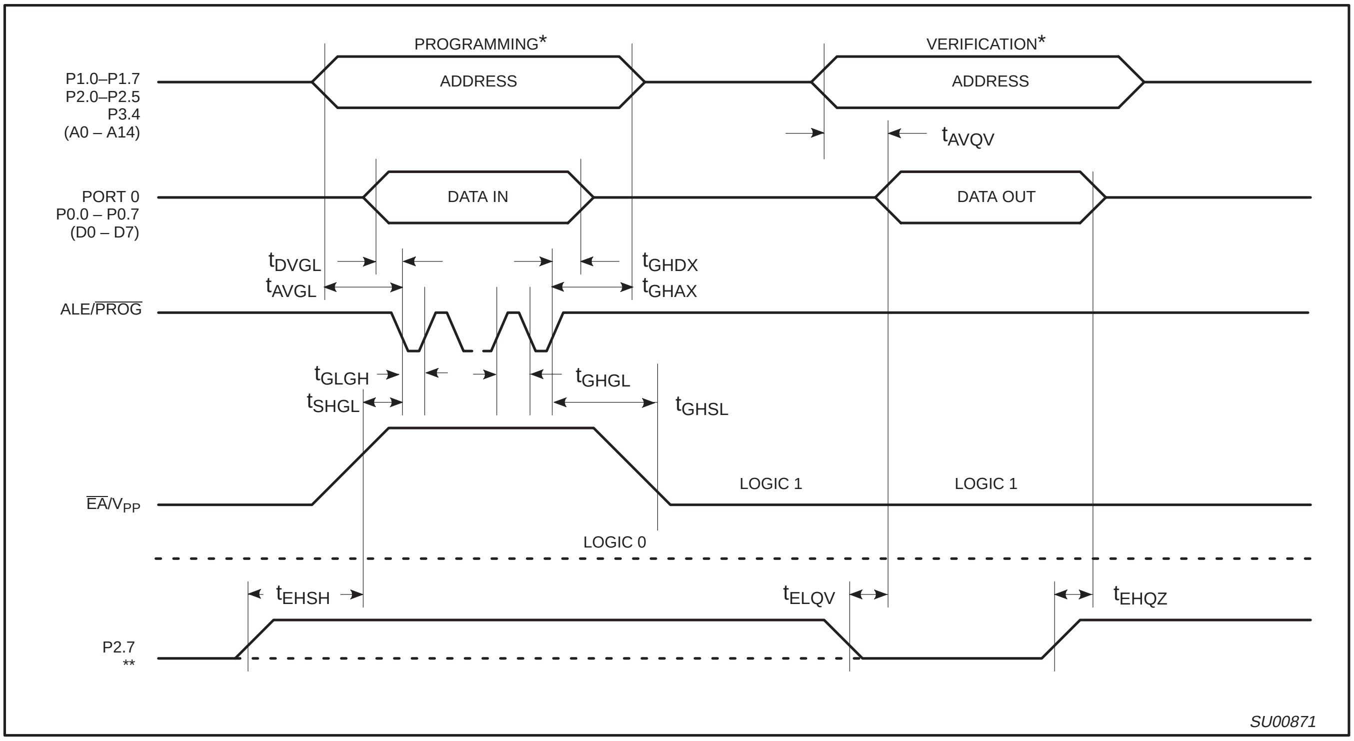
Figure 43. Program Verification

EPROM PROGRAMMING AND VERIFICATION CHARACTERISTICS

T_{amb} = 21°C to +27°C, V_{CC} = 5V±10%, V_{SS} = 0V (See Figure 44)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V_{PP}	Programming supply voltage	12.5	13.0	V
I_{PP}	Programming supply current		50 [1]	mA
$1/t_{CLCL}$	Oscillator frequency	4	6	MHz
t_{AVGL}	Address setup to $\overline{PROG}$ low	$48t_{CLCL}$		
t_{GHAX}	Address hold after $\overline{PROG}$	$48t_{CLCL}$		
t_{DVGL}	Data setup to $\overline{PROG}$ low	$48t_{CLCL}$		
t_{GHDX}	Data hold after $\overline{PROG}$	$48t_{CLCL}$		
t_{EHSH}	P2.7 ($\overline{ENABLE}$) high to V_{PP}	$48t_{CLCL}$		
t_{SHGL}	V_{PP} setup to $\overline{PROG}$ low	10		µs
t_{GHSL}	V_{PP} hold after $\overline{PROG}$	10		µs
t_{GLGH}	$\overline{PROG}$ width	90	110	µs
t_{AVQV}	Address to data valid		$48t_{CLCL}$	
t_{ELQZ}	$\overline{ENABLE}$ low to data valid		$48t_{CLCL}$	
t_{EHQZ}	Data float after $\overline{ENABLE}$	0	$48t_{CLCL}$	
t_{GHGL}	$\overline{PROG}$ high to $\overline{PROG}$ low	10		µs

NOTE:
1. Not tested.



NOTES:
* FOR PROGRAMMING CONFIGURATION SEE FIGURE 41.
FOR VERIFICATION CONDITIONS SEE FIGURE 43.
** SEE TABLE 9.

Figure 44. EPROM Programming and Verification

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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